

L Number	Hits	Search Text	DB	Time stamp
-	9030	amorphous and LED	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/08 14:28
-	3990	(amorphous and LED) and (interface or bond)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 09:39
-	157	((amorphous and LED) and (interface or bond)) and (InP and GaAs)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 10:39
-	1	("5985687").PN.	USPAT	2003/02/27 09:42
-	539	438/455.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 10:41
-	115	438/455.ccls. and amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 13:17
-	58	438/470.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 13:20
-	987	257/94,95.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 13:20
-	284	257/94,95.ccls. and (amorphous or bond\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 13:22
-	73	257/94,95.ccls. and amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 14:31
-	4	((4734576) or (4955699) or (5602418) or (5625202)).PN.	USPAT	2003/02/27 14:32
-	2017	257/96,97,100,103.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 14:34
-	213	257/96,97,100,103.ccls. and amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 15:35
-	1412	InP and GaAs and amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 15:35
-	946	(InP and GaAs and amorphous) and (LED\$2 or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 15:37

-	935	InP and GaAs and amorphous and laser\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 13:12
-	316	(InP and GaAs and amorphous and laser\$2) and 438/\$\$\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 13:56
-	5342	372/43.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 13:57
-	20	372/43.ccls. and amorphous and InP	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 13:59
-	65	372/43.ccls. and amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 14:34
-	9396	amorphous and (fuse or fusion)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 14:37
-	286	(amorphous and (fuse or fusion)) and ((InP/GaAs) or InP or GaAs)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 14:36
-	13	amorphous and wafer adj1 fusion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 15:13
-	2264	wafer adj1 fusion or wafer adj1 bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 15:14
-	365	(wafer adj1 fusion or wafer adj1 bonding) and amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 15:15
-	84	((wafer adj1 fusion or wafer adj1 bonding) and amorphous) and InP	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 16:08
-	416	257/627.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 16:43
-	1591	438/48,22,46,47.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/28 16:46
-	2455	amorphous and LED and bond	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:36

-	767	((amorphous and LED and bond) and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:38
-	1611014	((amorphous and LED and bond) and laser) vertical	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:38
-	269	((amorphous and LED and bond) and laser) and vertical	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:45
-	5	(bond or bonded or bonding) and (fuse or fusion) and amorphous and VCSEL\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:52
-	1243	(bond or bonded or bonding) and (fuse or fusion) and amorphous and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:47
-	47	((bond or bonded or bonding) and (fuse or fusion) and amorphous and laser) and (GaAs and InP)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:48
-	46	(bond or bonded or bonding) and (fuse or fusion) and amorphous adj1 layer and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/08 13:57
-	4	((("4734576") or ("4955699") or ("5602418") or ("5625202")) .PN.	USPAT	2003/03/08 13:58
-	1	SIGLE-WERNER	USPAT	2003/03/08 14:29
-	12	BLACK-A	USPAT	2003/03/08 14:30